Low-ohmic dual single-pole double-throw analog switchRev. 2 — 8 November 2011Product data sheet

1. General description

The NX3L2267S is a dual low-ohmic single-pole double-throw analog switch suitable for use as an analog or digital 2 : 1 multiplexer/demultiplexer. Each switch has a digital select input (nS), two independent inputs/outputs (nY0 and nY1) and a common input/output (nZ).

The NX3L2267S includes termination resistors that improve noise immunity during overshoot excursions, off-isolation coupling, or pop-minimization.

Schmitt trigger action at the digital inputs makes the circuit tolerant to slower input rise and fall times. Low threshold digital inputs allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I_{CC}. This makes it possible for the NX3L2267S to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L2267S allows signals with amplitude up to V_{CC} to be transmitted from nZ to nY0 or nY1, or from nY0 or nY1 to nZ. Its low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
 - 1.65 Ω (typical) at V_{CC} = 1.4 V
 - 0.95 Ω (typical) at V_{CC} = 1.65 V
 - 0.55 Ω (typical) at V_{CC} = 2.3 V
 - 0.50 Ω (typical) at V_{CC} = 2.7 V
 0.50 Ω (typical) at V_{CC} = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 7500 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD78B Class II Level A
- 1.8 V control logic at V_{CC} = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V_{CC}
- High current handling capability (350 mA continuous current under 3.3 V supply)



■ Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Applications

- Cell phone
- PDA
- Portable media player

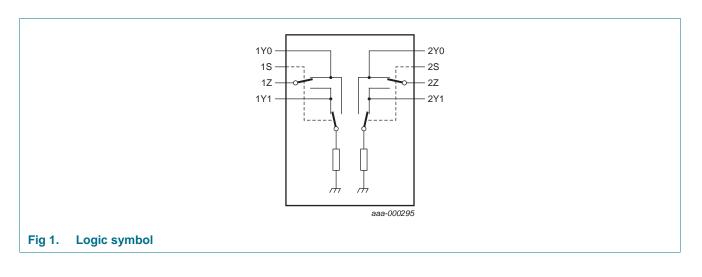
4. Ordering information

| Table 1. Ordering information | | | | | | | | |
|-------------------------------|-------------------|--------|---|-----------|--|--|--|--|
| Type number | Package | | | | | | | |
| | Temperature range | Name | Description | Version | | | | |
| NX3L2267SGU | –40 °C to +125 °C | XQFN10 | plastic, extremely thin quad flat package; no leads; 10 terminals; body $1.40 \times 1.80 \times 0.50$ mm | SOT1160-1 | | | | |

5. Marking

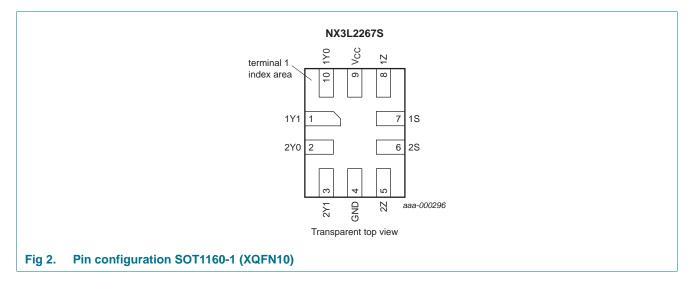
| Table 2. Marking | |
|------------------|--------------|
| Type number | Marking code |
| NX3L2267SGU | MS |

6. Functional diagram



7. Pinning information

7.1 Pinning



7.2 Pin description

| Table 3. | Pin description | | |
|-----------------|-----------------|-----|-----------------------------|
| Symbol | | Pin | Description |
| 1Y0 | | 10 | independent input or output |
| 1Y1 | | 1 | independent input or output |
| 2Y0 | | 2 | independent input or output |
| 2Y1 | | 3 | independent input or output |
| GND | | 4 | ground (0 V) |
| 2Z | | 5 | common output or input |
| 2S | | 6 | select input |
| 1S | | 7 | select input |
| 1Z | | 8 | common output or input |
| V _{CC} | | 9 | supply voltage |

8. Functional description

| Table 4. Function table ^[1] | |
|--|-----------------------------------|
| Input nS | Channel on |
| L | nY0 = nZ; $nY1$ terminated to GND |
| Н | nY1 = nZ; $nY0$ terminated to GND |

[1] H = HIGH voltage level; L = LOW voltage level.

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|-----------------|-----------------------|------|
| V _{CC} | supply voltage | | -0.5 | +4.6 | V |
| VI | input voltage | select input nS | <u>[1]</u> –0.5 | +4.6 | V |
| V _{SW} | switch voltage | nZ ON or OFF; nYn ON | 2 -0.5 | V _{CC} + 0.5 | V |
| | | nYn OFF | 0 | 1.4 | V |
| I _{IK} | input clamping current | $V_{l} < -0.5 V$ | -50 | - | mA |
| I _{SK} | switch clamping current | $V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V | - | ±50 | mA |
| I _{SW} | switch current | V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; source or sink current | - | ±350 | mA |
| | | V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current | - | ±500 | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 \text{ °C to } +125 \text{ °C}$ | [3] _ | 250 | mW |

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For XQFN10 package: above 133 °C the value of P_{tot} derates linearly with 11.5 mW/K.

10. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------------------|-------------------------------------|--|--------------|-----------------|------|
| V _{CC} | supply voltage | | 1.4 | 4.3 | V |
| VI | input voltage | select input nS | 0 | 4.3 | V |
| V _{SW} | switch voltage | switch input nY0 or nY1 | <u>[1]</u> 0 | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +125 | °C |
| $\Delta t / \Delta V$ | input transition rise and fall rate | $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$ | [2] _ | 200 | ns/V |

[1] To avoid sinking GND current from terminal nZ when switch current flows in terminal nYn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nYn. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to select input nS signal levels.

NX3L2267S

11. Static characteristics

Table 7. Static characteristics

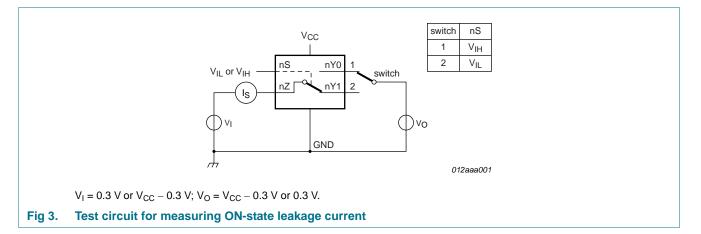
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

| Symbol | Parameter | Conditions | | T _{amb} = 25 | °C | T _{amb} = · | –40 °C to | +125 °C | Unit |
|--------------------|--------------------------|--|-------------|-----------------------|------|----------------------|----------------|-----------------|------|
| | | | Min | Тур | Max | Min | Max (85 °C) | Max (125 °C) | |
| V _{IH} | HIGH-level | V _{CC} = 1.4 V to 1.6 V | 0.9 | - | - | 0.9 | - | - | V |
| | input voltage | V_{CC} = 1.65 V to 1.95 V | 0.9 | - | - | 0.9 | - | - | V |
| | | V_{CC} = 2.3 V to 2.7 V | 1.1 | - | - | 1.1 | - | - | V |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 1.3 | - | - | 1.3 | - | - | V |
| | | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$ | 1.4 | - | - | 1.4 | - | - | V |
| V _{IL} | LOW-level | V_{CC} = 1.4 V to 1.6 V | - | - | 0.3 | - | 0.3 | 0.3 | V |
| | input voltage | V_{CC} = 1.65 V to 1.95 V | - | - | 0.4 | - | 0.4 | 0.3 | V |
| | | V_{CC} = 2.3 V to 2.7 V | - | - | 0.5 | - | 0.5 | 0.4 | V |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | - | - | 0.5 | - | 0.5 | 0.5 | V |
| | | V_{CC} = 3.6 V to 4.3 V | - | - | 0.6 | - | 0.6 | 0.6 | V |
| I | input leakage current | select input nS; V _I = GND to 4.3 V; V _{CC} = 1.4 V to 4.3 V | - | - | - | - | ±0.5 | ±1 | μA |
| I _{S(ON)} | ON-state | nZ port; see Figure 3 | | | | | | | |
| | leakage current | V_{CC} = 1.4 V to 4.3 V | - | - | ±50 | - | ±150 | ±1500 | nA |
| I _{CC} | supply current | $V_I = V_{CC}$ or GND; $V_{SW} = GND$ or V_{CC} | | | | | | | |
| | | $V_{CC} = 3.6 V$ | - | - | 100 | - | 300 | 3000 | nA |
| | | $V_{CC} = 4.3 V$ | - | - | 150 | - | 500 | 5000 | nA |
| ΔI_{CC} | additional | V_{SW} = GND or V_{CC} | | | | | | | |
| | supply current | $V_{I} = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$ | - | 2.0 | 4.0 | - | 7 | 7 | μA |
| | | $V_{I} = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$ | - | 0.35 | 0.7 | - | 1 | 1 | μΑ |
| | | $V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$ | - | 7.0 | 10.0 | - | 15 | 15 | μΑ |
| | | $V_{I} = 1.8 \text{ V}; V_{CC} = 3.6 \text{ V}$ | - | 2.5 | 4.0 | - | 5 | 5 | μΑ |
| | | V_{I} = 1.8 V; V_{CC} = 2.5 V | - | 50 | 200 | - | 300 | 500 | nA |
| R _T | termination resistance | $V_{SW} = 1.0 \text{ V}; V_{CC} = 3.0 \text{ V}$ | <u>1]</u> - | 200 | - | - | - | - | Ω |
| CI | input capacitance | | - | 1.0 | - | - | - | - | pF |
| $C_{S(OFF)}$ | OFF-state capacitance | port nYn | - | 35 | - | - | - | - | pF |
| $C_{S(ON)}$ | ON-state capacitance | port nYn | - | 135 | - | - | - | - | pF |

[1] Guaranteed by characterization, not production tested.

Low-ohmic dual single-pole double-throw analog switch

11.1 Test circuits



11.2 ON resistance

Table 8.ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 5 to Figure 11.

| Symbol | Parameter | Conditions | –40 °C to + | | 35 °C | -40 °C to | +125 °C | Unit |
|-----------------------|---|---|-------------|--------|-------|-----------|---------|------|
| | | | Min | Typ[1] | Max | Min | Max | |
| R _{ON(peak)} | ON resistance (peak) | port nYn; V _I = GND to V _{CC} ; I _{SW} = 100 mA; see Figure 4 | | | | | | |
| | | V _{CC} = 1.4 V | - | 1.65 | 3.7 | - | 4.1 | Ω |
| | | V _{CC} = 1.65 V | - | 0.95 | 1.6 | - | 1.7 | Ω |
| | | $V_{CC} = 2.3 V$ | - | 0.55 | 0.8 | - | 0.9 | Ω |
| | | $V_{CC} = 2.7 V$ | - | 0.50 | 0.75 | - | 0.9 | Ω |
| | | $V_{CC} = 4.3 V$ | - | 0.50 | 0.75 | - | 0.9 | Ω |
| ΔR_{ON} | ON resistance mismatch between channels | $V_I = GND \text{ to } V_{CC};$ [2] $I_{SW} = 100 \text{ mA}$ | | | | | | |
| | | V _{CC} = 1.4 V | - | 0.20 | 0.35 | - | 0.35 | Ω |
| | | V _{CC} = 1.65 V | - | 0.20 | 0.25 | - | 0.30 | Ω |
| | | $V_{CC} = 2.3 V$ | - | 0.09 | 0.13 | - | 0.15 | Ω |
| | | $V_{CC} = 2.7 V$ | - | 0.09 | 0.125 | - | 0.15 | Ω |
| | | $V_{CC} = 4.3 V$ | - | 0.09 | 0.125 | - | 0.15 | Ω |

NX3L2267S

Low-ohmic dual single-pole double-throw analog switch

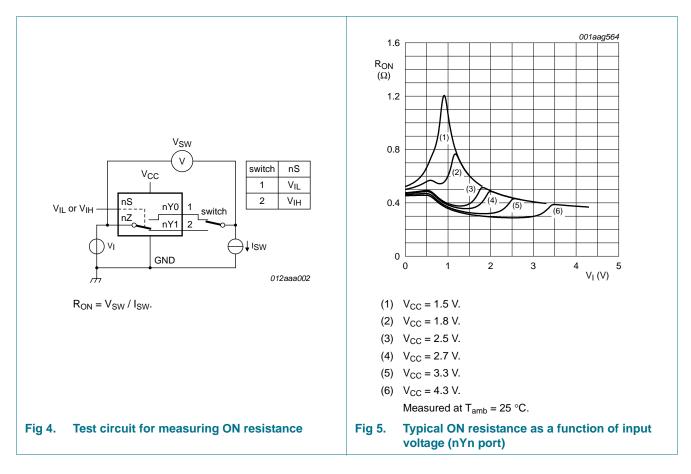
| At recomm | nended operating condition | s; voltages are referenced to GN | VD (| grour | d = 0 V); | for grap | hs see <mark>Fig</mark> | <u>ure 5</u> to <u>Fi</u> | <u>gure 11</u> . |
|--|---|----------------------------------|------|-------|----------------------|----------|-------------------------|---------------------------|------------------|
| Symbol | Parameter | Conditions | | -40 | °C to +8 | 5 °C | –40 °C to | +125 °C | Unit |
| | | | N | | Typ <mark>[1]</mark> | Max | Min | Max | |
| R _{ON(flat)} ON resistance (flatness) | port nYn; $V_I = GND$ to V_{CC} ; $I_{SW} = 100 \text{ mA}$ | 1 | | | | | | | |
| | | $V_{CC} = 1.4 V$ | | - | 1.05 | 3.35 | - | 3.65 | Ω |
| | | V _{CC} = 1.65 V | | - | 0.55 | 1.25 | - | 1.35 | Ω |
| | | $V_{CC} = 2.3 V$ | | - | 0.20 | 0.35 | - | 0.40 | Ω |
| | $V_{CC} = 2.7 V$ | | - | 0.18 | 0.35 | - | 0.40 | Ω | |
| | | $V_{CC} = 4.3 V$ | | - | 0.23 | 0.40 | - | 0.45 | Ω |

Table 8. **ON resistance** ... continued

[1] Typical values are measured at T_{amb} = 25 °C.

Measured at identical $V_{\mbox{CC}},$ temperature and input voltage. [2]

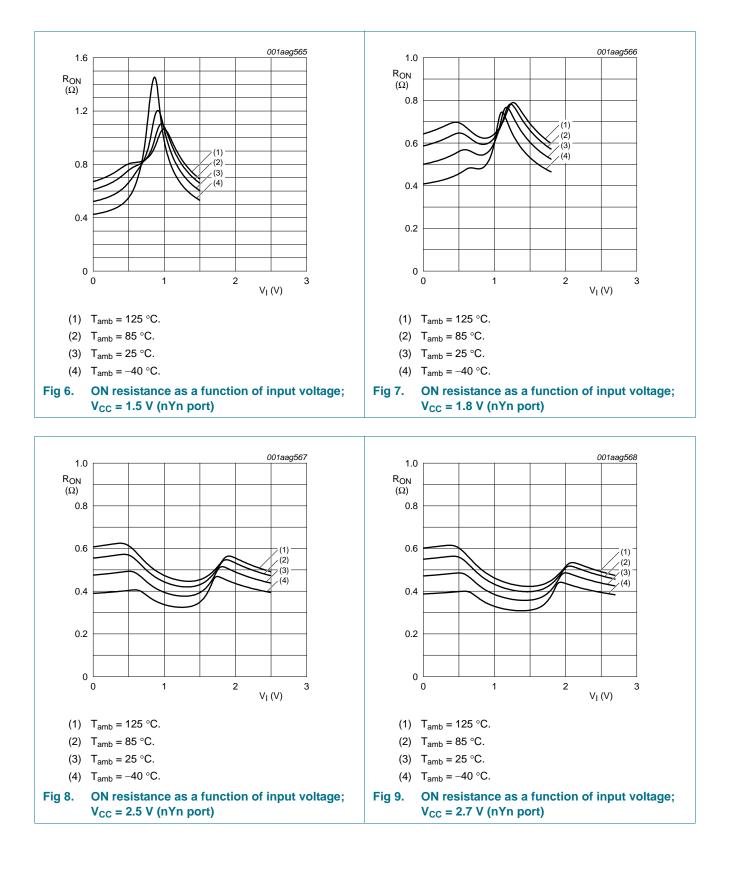
Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and [3] temperature.



11.3 ON resistance test circuit and graphs

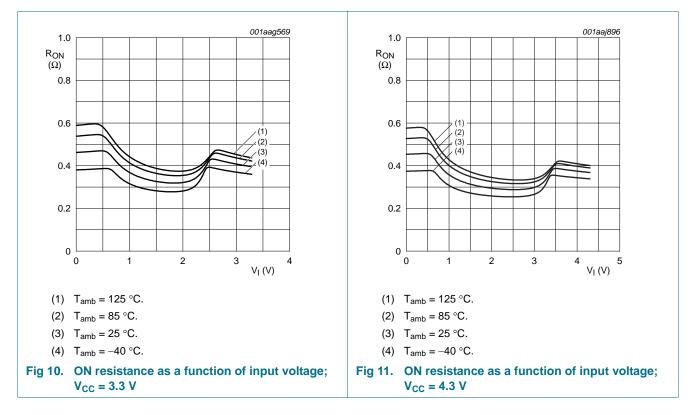
NX3L2267S

Low-ohmic dual single-pole double-throw analog switch



NX3L2267S

Low-ohmic dual single-pole double-throw analog switch



12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 14.

| Symbol | Parameter | Conditions | Ta | _{mb} = 25 | °C | T _{amb} = | –40 °C to | +125 °C | Unit |
|------------------|--------------|--|-----|----------------------|-----|--------------------|----------------|-----------------|------|
| | | | Min | Typ <mark>[1]</mark> | Мах | Min | Max (85 °C) | Max (125 °C) | |
| t _{en} | enable time | nS to nZ or nYn; see <u>Figure 12</u> | | | | | | | |
| | | V_{CC} = 1.4 V to 1.6 V | - | 50 | 90 | - | 120 | 120 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | - | 36 | 70 | - | 80 | 90 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | - | 24 | 45 | - | 50 | 55 | ns |
| | | V_{CC} = 2.7 V to 3.6 V | - | 22 | 40 | - | 45 | 50 | ns |
| | | V_{CC} = 3.6 V to 4.3 V | - | 22 | 40 | - | 45 | 50 | ns |
| t _{dis} | disable time | nS to nZ or nYn; see <u>Figure 12</u> | | | | | | | |
| | | V_{CC} = 1.4 V to 1.6 V | - | 32 | 70 | - | 80 | 90 | ns |
| | | V_{CC} = 1.65 V to 1.95 V | - | 20 | 55 | - | 60 | 65 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | - | 12 | 25 | - | 30 | 35 | ns |
| | | V_{CC} = 2.7 V to 3.6 V | - | 10 | 20 | - | 25 | 30 | ns |
| | | V_{CC} = 3.6 V to 4.3 V | - | 10 | 20 | - | 25 | 30 | ns |

Low-ohmic dual single-pole double-throw analog switch

| Symbol | Parameter | Conditions | Conditions | | _{mb} = 25 | °C | T _{amb} = | –40 °C to | +125 °C | Unit |
|------------------|-------------------|--|------------|-----|----------------------|-----|--------------------|----------------|-----------------|------|
| | | | | Min | Typ <mark>[1]</mark> | Мах | Min | Max (85 °C) | Max (125 °C) | |
| t _{b-m} | break-before-make | see Figure 13 | [2] | | | | | | | |
| | time | V_{CC} = 1.4 V to 1.6 V | | - | 19 | - | 9 | - | - | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | - | 17 | - | 7 | - | - | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | - | 13 | - | 4 | - | - | ns |
| | | V_{CC} = 2.7 V to 3.6 V | | - | 10 | - | 3 | - | - | ns |
| | | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$ | | - | 10 | - | 2 | - | - | ns |

Table 9. Dynamic characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 14.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

12.1 Waveform and test circuits

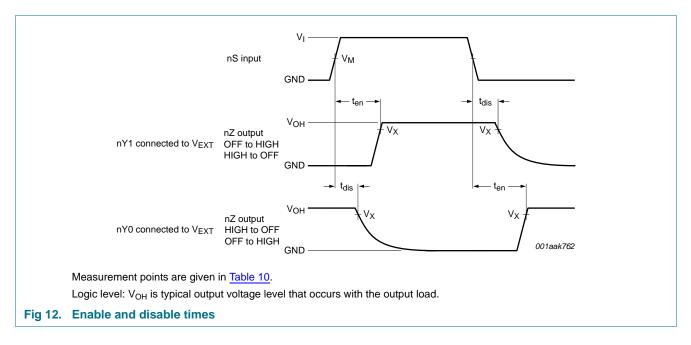
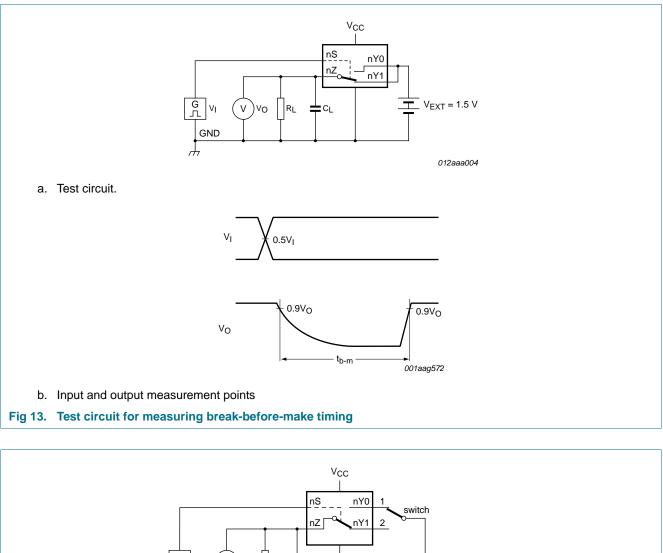


Table 10.Measurement points

| Supply voltage | Input | Output |
|-----------------|--------------------|--------------------|
| V _{cc} | V _M | V _X |
| 1.4 V to 4.3 V | 0.5V _{CC} | 0.9V _{OH} |

NX3L2267S

Low-ohmic dual single-pole double-throw analog switch



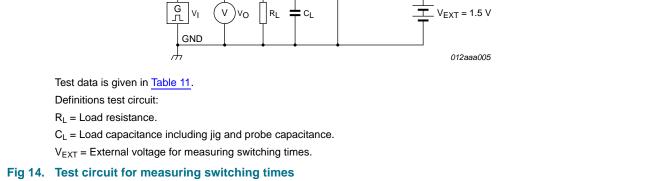


Table 11. Test data

| Supply voltage | Input | | Load | | |
|-----------------|-----------------|---------------------------------|-------|------|--|
| V _{cc} | VI | t _r , t _f | CL | RL | |
| 1.4 V to 4.3 V | V _{CC} | ≤ 2.5 ns | 35 pF | 50 Ω | |

| NX3L2267S | | | |
|----------------|------|-------|--|
| Product | data | sheet | |

12.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

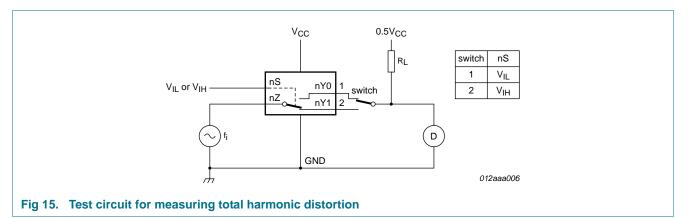
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns.

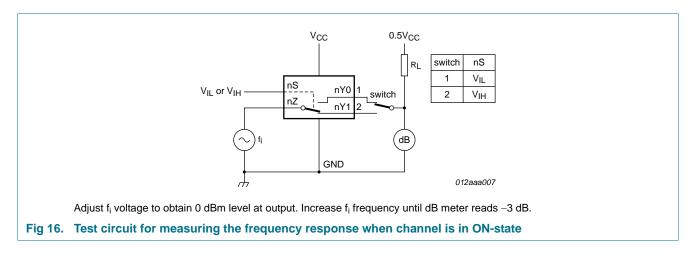
| Symbol | Parameter | Conditions | | T _{amb} = 25 °C | | | Unit |
|-----------------------|------------------------------|--|------------|--------------------------|------|-----|------|
| | | | | Min | Тур | Max | - |
| THD | total harmonic distortion | $f_i = 20$ Hz to 20 kHz; $R_L = 32 \Omega$; see Figure 15 | [1] | | 1 | | |
| | | V _{CC} = 1.4 V; V _I = 1 V (p-p) | | - | 0.15 | - | % |
| | | V _{CC} = 1.65 V; V _I = 1.2 V (p-p) | | - | 0.10 | - | % |
| | | V _{CC} = 2.3 V; V _I = 1.5 V (p-p) | | - | 0.02 | - | % |
| | | $V_{CC} = 2.7 \text{ V}; \text{ V}_{I} = 2 \text{ V} (p-p)$ | | - | 0.02 | - | % |
| | | V _{CC} = 4.3 V; V _I = 2 V (p-p) | | - | 0.02 | - | % |
| | | V_{CC} = 3.0 V; V _I = 1 V (p-p); R _L = 600 Ω | | - | 0.01 | - | % |
| f _(-3dB) | -3 dB frequency | $R_L = 50 \Omega$; see Figure 16 | [1] | | | | |
| | response | port nYn; V_{CC} = 1.4 V to 4.3 V | | - | 60 | - | MHz |
| α_{iso} | isolation (OFF-state) | $f_i = 100 \text{ kHz}; R_L = 50 \Omega; \text{ see } \frac{\text{Figure } 17}{100}$ | [1] | | | | |
| | | $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$ | | - | -90 | - | dB |
| V _{ct} | crosstalk voltage | between digital inputs and switch; $f_i = 1 \text{ MHz}$; $C_L = 50 \text{ pF}$; $R_L = 50 \Omega$; see Figure 18 | | | | | |
| | | V _{CC} = 1.4 V to 3.6 V | | - | 0.21 | - | V |
| | | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$ | | - | 0.30 | - | V |
| Xtalk cro | crosstalk | between switches; $f_i = 100 \text{ kHz; } R_L = 50 \Omega$; see Figure 19 | <u>[1]</u> | | | | |
| | | $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$ | | - | -90 | - | dB |
| Q _{inj} | charge injection | $f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; R_{gen} = 0 \Omega; \text{ see } \frac{\text{Figure 20}}{2}$ | | | | | |
| | | V _{CC} = 1.5 V | | - | 4 | - | рС |
| | | V _{CC} = 1.8 V | | - | 6 | - | рС |
| | | $V_{CC} = 2.5 V$ | | - | 16 | - | рС |
| | | $V_{CC} = 3.3 V$ | | - | 24 | - | рС |
| | | $V_{CC} = 4.3 V$ | | - | 37 | - | рС |

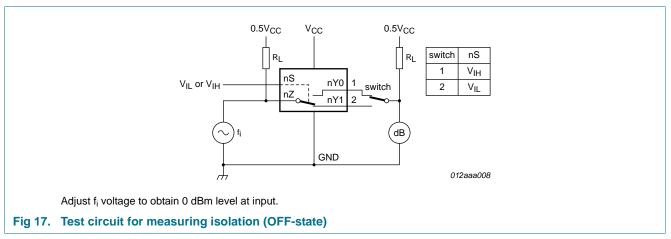
[1] f_i is biased at 0.5V_{CC}.

Low-ohmic dual single-pole double-throw analog switch

12.3 Test circuits

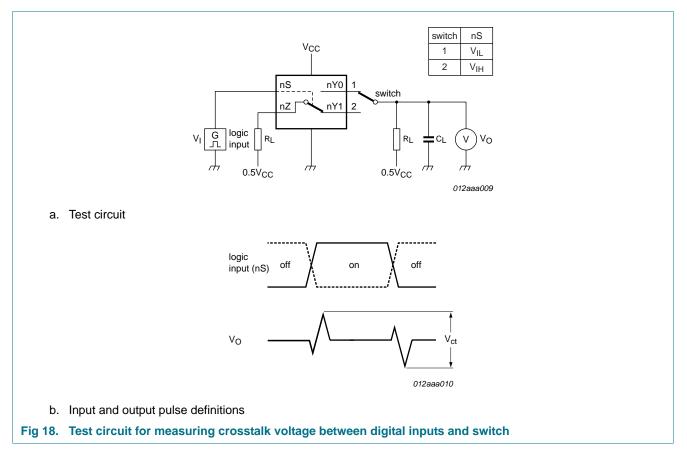


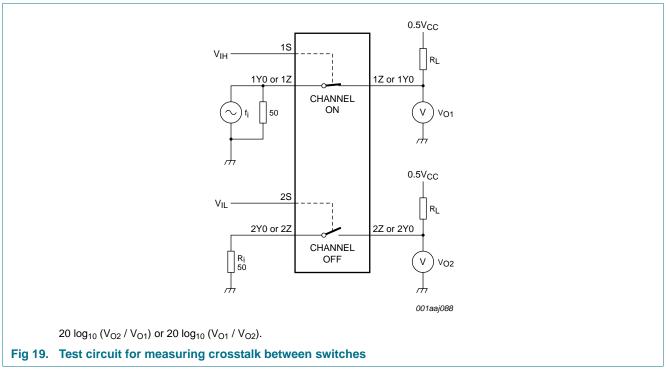




NX3L2267S Product data sheet

Low-ohmic dual single-pole double-throw analog switch

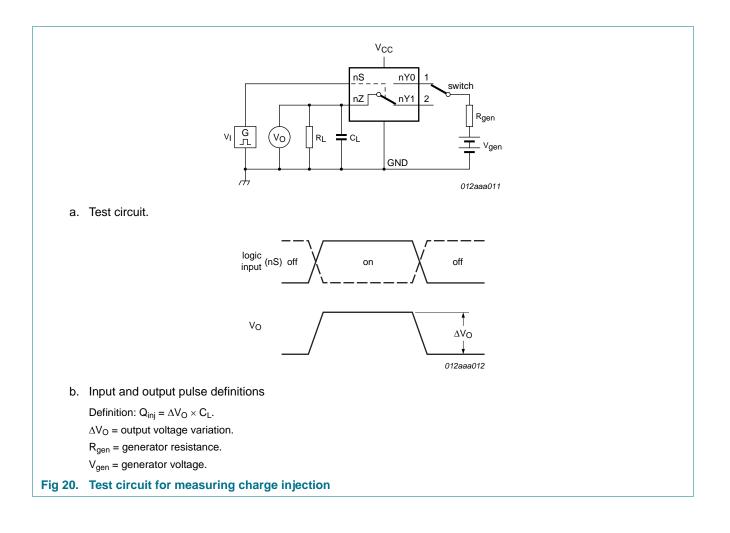




14 of 20

NX3L2267S

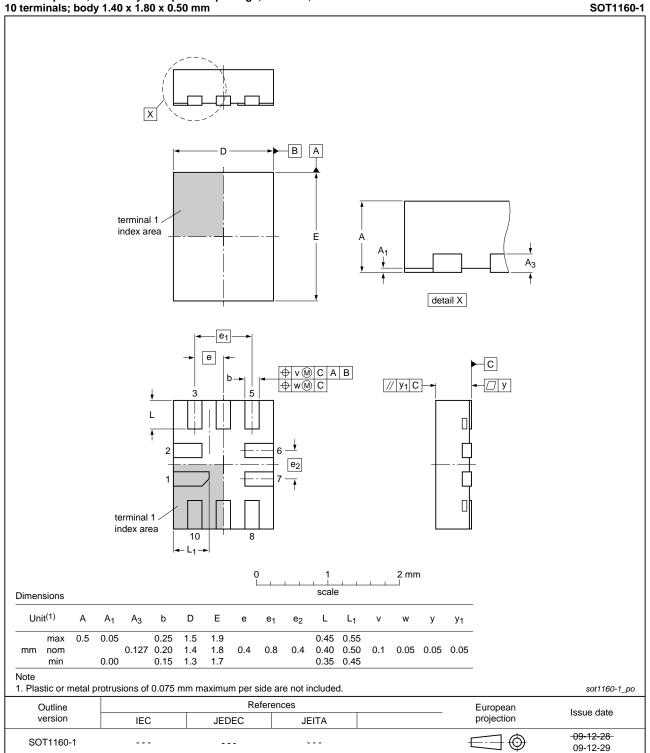
Low-ohmic dual single-pole double-throw analog switch



NX3L2267S

Low-ohmic dual single-pole double-throw analog switch

13. Package outline



XQFN10: plastic, extremely thin quad flat package; no leads; 10 terminals; body 1.40 x 1.80 x 0.50 mm

Fig 21. Package outline SOT1160-1 (XQFN10)

All information provided in this document is subject to legal disclaimers.

NX3L2267S

14. Abbreviations

| Table 13. Abbreviations | | | | |
|-------------------------|---|--|--|--|
| Acronym | Description | | | |
| CDM | Charged Device Model | | | |
| CMOS | Complementary Metal-Oxide Semiconductor | | | |
| ESD | ElectroStatic Discharge | | | |
| HBM | Human Body Model | | | |
| MM | Machine Model | | | |
| TTL | Transistor-Transistor Logic | | | |

15. Revision history

| Table 14. Revision history | | | | | |
|---------------------------------------|--------------|--------------------|---------------|---------------|--|
| Document ID | Release date | Data sheet status | Change notice | Supersedes | |
| NX3L2267S v.2 | 20111108 | Product data sheet | - | NX3L2267S v.1 | |
| Modifications: • Legal pages updated. | | | | | |
| NX3L2267S v.1 | 20110823 | Product data sheet | - | - | |

16. Legal information

16.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

16.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

16.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

NX3L2267S

© NXP B.V. 2011. All rights reserved.

Low-ohmic dual single-pole double-throw analog switch

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

17. Contact information

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

16.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

19 of 20

NX3L2267S

Low-ohmic dual single-pole double-throw analog switch

18. Contents

| 1 | General description 1 |
|------|--|
| 2 | Features and benefits 1 |
| 3 | Applications 2 |
| 4 | Ordering information 2 |
| 5 | Marking 2 |
| 6 | Functional diagram 2 |
| 7 | Pinning information 3 |
| 7.1 | Pinning |
| 7.2 | Pin description 3 |
| 8 | Functional description 4 |
| 9 | Limiting values 4 |
| 10 | Recommended operating conditions 4 |
| 11 | Static characteristics 5 |
| 11.1 | Test circuits 6 |
| 11.2 | ON resistance 6 |
| 11.3 | ON resistance test circuit and graphs7 |
| 12 | Dynamic characteristics 9 |
| 12.1 | Waveform and test circuits 10 |
| 12.2 | Additional dynamic characteristics 12 |
| 12.3 | Test circuits 13 |
| 13 | Package outline 16 |
| 14 | Abbreviations 17 |
| 15 | Revision history 17 |
| 16 | Legal information 18 |
| 16.1 | Data sheet status 18 |
| 16.2 | Definitions 18 |
| 16.3 | Disclaimers |
| 16.4 | Trademarks 19 |
| 17 | Contact information 19 |
| 18 | Contents 20 |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2011.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 8 November 2011 Document identifier: NX3L2267S